### FAIRCHILD

SEMICONDUCTOR

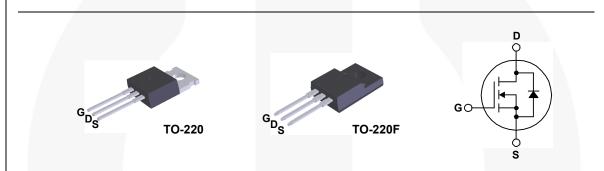
## FQP6N90C / FQPF6N90C **N-Channel QFET® MOSFET** 900 V, 6.0 A, 2.3 Ω

#### Description

This N-Channel enhancement mode power MOSFET is • 6.0 A, 900 V, R<sub>DS(on)</sub> = 2.3 Ω (Max.) @ V<sub>GS</sub> = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state . Low Gate Charge (Typ. 30 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 11 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

#### Features

- $I_{D} = 3.0 \text{ A}$



#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQP6N90C FQPF6N90C		Unit	
V <sub>DSS</sub>	Drain-Source Voltage	9	V		
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		6	6 *	А
	- Continuous (T <sub>C</sub> = 100°C)		3.8	3.8 *	А
DM	Drain Current - Pulsed	(Note 1)	24	24 *	А
V <sub>GSS</sub>	Gate-Source Voltage	±	V		
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	6	mJ	
AR	Avalanche Current	(Note 1)	6		А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1		10	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3		4.5		V/ns
PD	Power Dissipation ( $T_C = 25^{\circ}C$ )	167	56	W	
	- Derate above 25°C	1.43	0.48	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to	°C		
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds	3	°C		

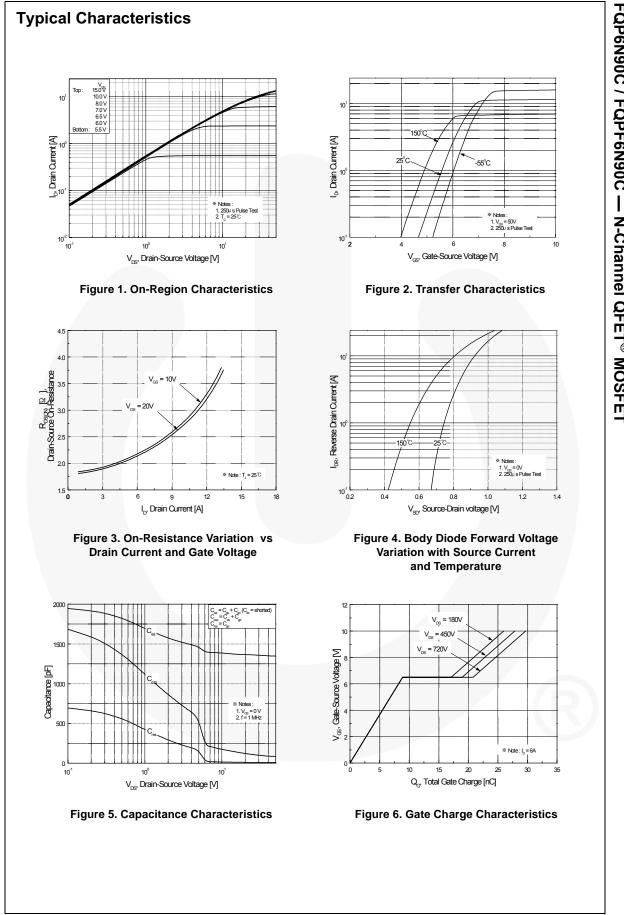
\* Drain current limited by maximum junction temperature.

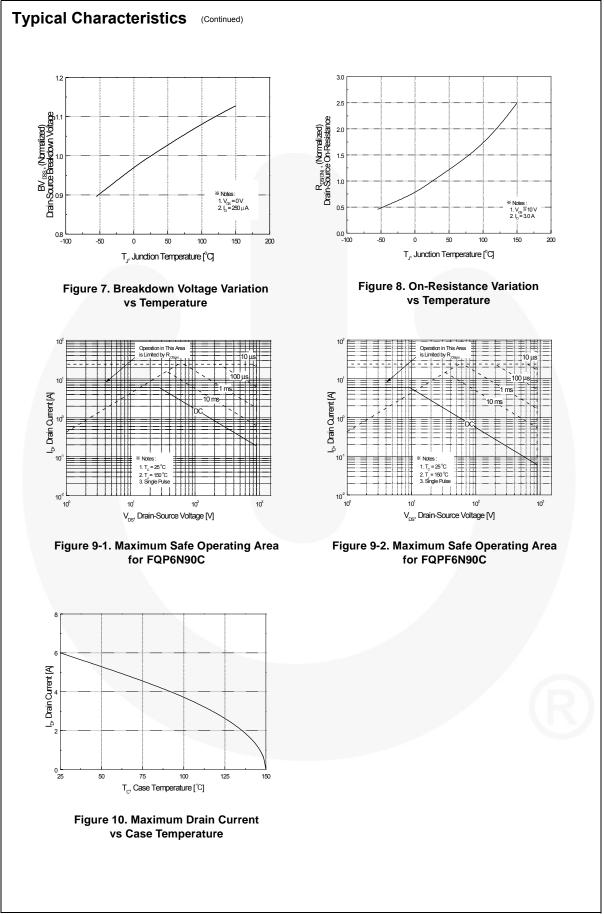
#### **Thermal Characteristics**

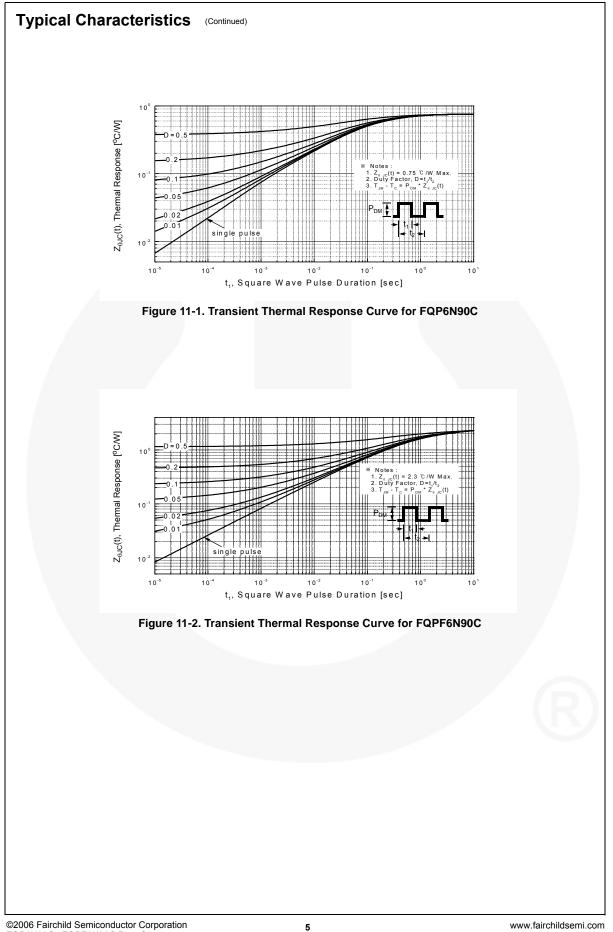
Symbol	Parameter	FQP6N90C	FQPF6N90C	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.75	2.25	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ, Max.	0.5		°C/W	
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W	

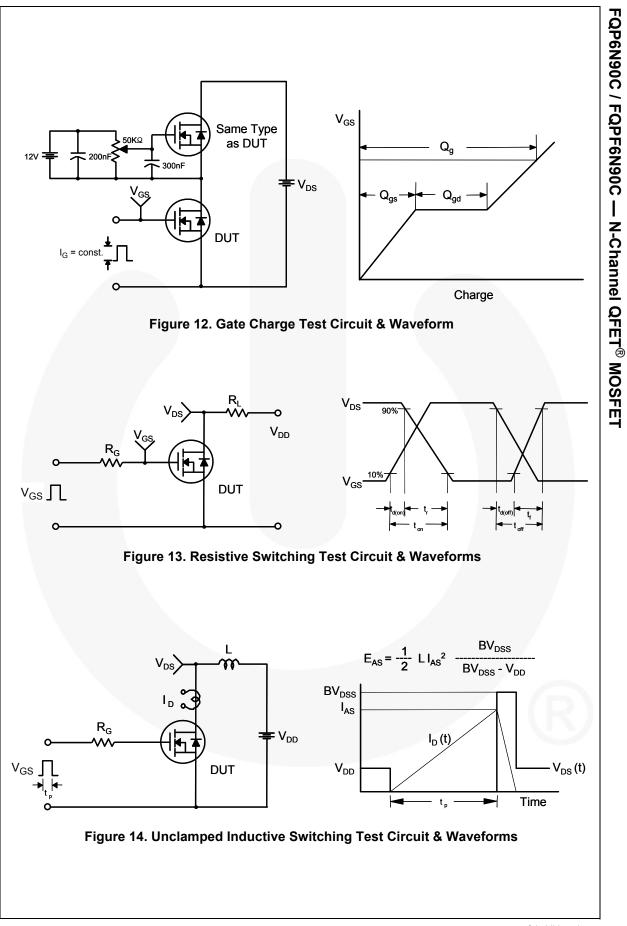
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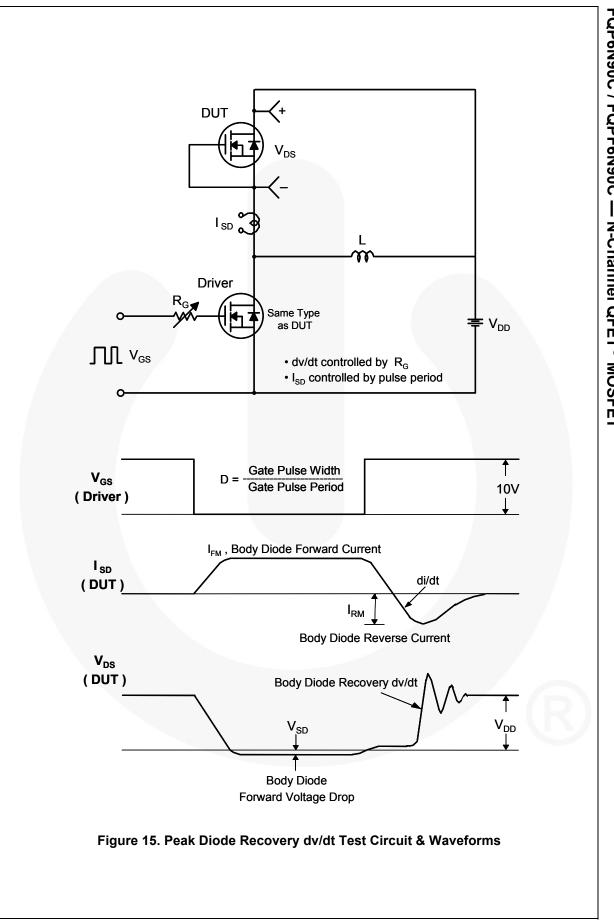
Part NumberTop MarkPackFQP6N90CFQP6N90CTO-FQPF6N90CFQPF6N90CTO-2		Top Mark	Pack	age	age Packing Method Reel S		Size	Tape Width		Quantity	
		FQP6N90C TO-		220 Tube N/A		4	N/A		50 units		
		20F Tube N/			4	N/A		50 units			
lectric	cal Cha	racteristics	T <sub>C</sub> = 25°C	c unless of	herwise noted						-i
Symbol		Parameter			Test Cor	nditions		Min.	Тур.	Max.	Unit
	racterist	ics									
SV <sub>DSS</sub>	Drain-Source Breakdown Voltage		$V_{GS}$ = 0 V, I <sub>D</sub> = 250 µA			900			V		
BV <sub>DSS</sub> MTJ	Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current		$I_D = 250 \ \mu$ A, Referenced to 25°C				1.07		V/°C		
DSS			$V_{DS} = 900 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 720 \text{ V}, T_C = 125^{\circ}\text{C}$					10 100	μA μA		
GSSF	Gate-Bod	Gate-Body Leakage Current, Forward		$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$						100	nA
GSSR		Gate-Body Leakage Current, Reverse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$						-100	nA
	racterist			00	, 00	-					
GS(th)	-	eshold Voltage	-	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 2$	250 μA		3.0		5.0	V
RDS(on)	Static Dra On-Resist			V <sub>GS</sub> =	10 V, I <sub>D</sub> =	3 A			1.93	2.3	Ω
FS	Forward 1	ransconductance		V <sub>DS</sub> = 50 V, I <sub>D</sub> = 3 A				5.5		S	
<b>)ynam</b> i <sub>Ziss</sub>	c Characteristics Input Capacitance		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,				1360	1770	pF		
oss	Output Ca	utput Capacitance everse Transfer Capacitance		f = 1.0 MHz				110	145	pF	
rss	Reverse 7							11	15	pF	
Switchi	ng Char	acteristics									
d(on)	Turn-On Delay Time		14 450141 0.4				35	80	ns		
	Turn-On F	Rise Time	-		$V_{DD}$ = 450 V, $I_D$ = 6 A, R <sub>G</sub> = 25 $\Omega$			90	190	ns	
l(off)	Turn-Off [	Delay Time		n <sub>G</sub> -	2.5 12				55	120	ns
(- )	Turn-Off F	all Time					(Note 4)		60	130	ns
2 <sub>g</sub>	Total Gate	e Charge		V <sub>De</sub> =	720 V, I <sub>D</sub> =	• 6 A,			30	40	nC
) <sub>gs</sub>	Gate-Sou	rce Charge			$V_{GS} = 10 V$			-	9.0		nC
) <sub>gd</sub>	Gate-Drai	n Charge					(Note 4)	-	12		nC
	ource Di	ode Characteri	istics ar	nd Ma	ximum R	atings			1 1		
3		Continuous Drain-S				•				6.0	Α
SM		Aaximum Pulsed Drain-Source Diode F								24	A
SD		Drain-Source Diode Forward Voltage			$V_{GS} = 0 V, I_{S} = 6 A$				)	1.4	V
r	Reverse F	se Recovery Time		$V_{GS} = 0 V, I_S = 6 A,$				630		ns	
) <sup>ut</sup>	Reverse Recovery Charge		dI <sub>F</sub> / dt = 100 A/μs				6.9		μC		
L = 34 mH, I	$I_{AS} = 6 \text{ A}, V_{DD}$ li/dt $\leq$ 200 A/µs	th limited by maximum jur = 50 V, R <sub>G</sub> = 25 Ω, starting s , V <sub>DD</sub> $\leq$ BV <sub>DSS</sub> , starting	$T_1 = 25^{\circ}C.$	ature.							

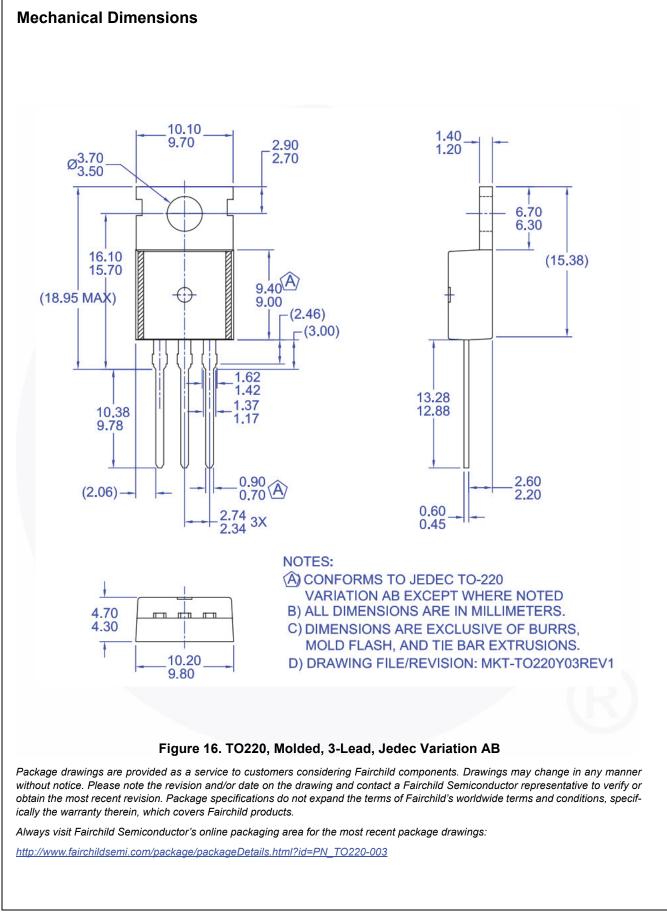








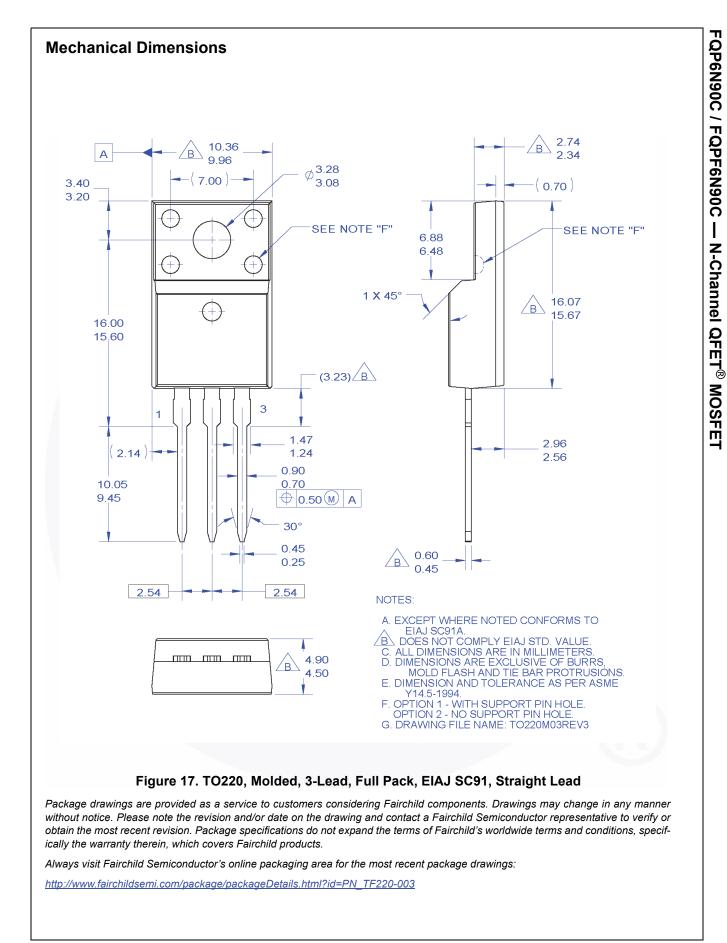




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**N-Channel QFET<sup>®</sup> MOSFET** 





Preliminary

No Identification Needed

Obsolete

First Production

**Full Production** 

Not In Production

notice to improve design.

Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.

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